

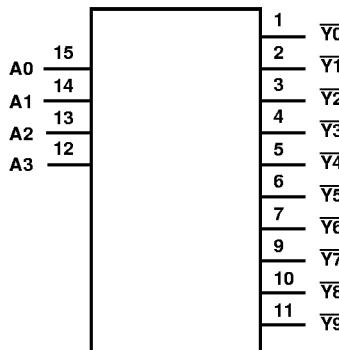
BCD-to-Decimal Decoder (1-to-10)

This device is fully compliant to the requirements of paragraph 1.2.1 of MIL-STD-883.

The CD54HC42F3A and CD54HCT42F3A BCD-to-Decimal decoders utilize silicon-gate CMOS technology to achieve operating speeds similar to LSTTL decoders with the low power consumption of standard CMOS integrated circuits. These devices have the capability of driving 10 LSTTL loads and are compatible with the standard 54LS logic family. One of 10 outputs (low on select) is selected in accordance with the BCD input. Non-valid BCD inputs result in none of the outputs being selected (all outputs are high).

For related information on this device, refer to the commercial data sheet in Harris AnswerFAX.

Functional Diagram



Absolute Maximum Ratings

DC Supply Voltage, V _{CC}	
Voltages Referenced to GND	-0.5V to +7.0V
DC Input Voltage Range, All Inputs, V _{IN}	-0.5V to V _{CC} + 0.5V
DC Output Voltage Range, All Outputs, V _{OUT}	-0.5V to V _{CC} + 0.5V
DC Input Diode Current, I _{IK}	
For V _I < -0.5V or V _I > V _{CC} + 0.5V	±20mA
DC Output Diode Current, I _{OK}	
For V _O < -0.5V or V _O > V _{CC} + 0.5V	±20mA
DC Drain Current, Per Output, I _O , for -0.5V < V _O < V _{CC} + 0.5V	±25mA
DC V _{CC} or GND Current, I _{CC}	±50mA

Power Dissipation Per Package, P _D	
T _A = -55°C to +100°C (Package F)	500mW
T _A = +100°C to +125°C (Package F)	Derate Linearly at 8mW/°C to 300mW
Operating Temperature Range, T _A	
Package Type F	-55°C to +125°C
Storage Temperature, T _{STG}	-65°C to +150°C
Lead Temperature (During Soldering)	
At Distance 1/16in. ± 1/32in. (1.59mm ± 0.79mm)	
From Case For 10s Max.	+265°C
Unit Inserted Into a PC Board (Min Thickness 1/16in., 1.59mm)	
With Solder Contacting Lead Tips Only	+300°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Recommended Operating Conditions

Supply Voltage Range, V _{CC}	
T _A = Full Package Temperature Range	
CD54HC Types	2V to 6V
CD54HCT Types	4.5V to 5.5V
DC Input or Output Voltage, V _{IN} , V _{OUT}	0V to V _{CC}

Operating Temperature Range, T _A	-55°C to +125°C
Input Rise and Fall Times, t _R , t _F	
at 2V	0ns to 1000ns
at 4.5V	0ns to 500ns
at 6V	0ns to 400ns

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DC Electrical Specifications - CD54HC Series

PARAMETERS	SYMBOL	TEST CONDITIONS			$T_A = +25^\circ\text{C}$		$T_A = -55^\circ\text{C}$ TO $+125^\circ\text{C}$		UNITS	
		V_{IN} (V)		V_{CC} (V)	MIN	MAX	MIN	MAX		
High Level Input Voltage	V_{IH}			2	1.5	-	1.5	-	V	
				4.5	3.15 (Note 1)	-	3.15 (Note 1)	-	V	
				6	4.2	-	4.2	-	V	
Low Level Input Voltage	V_{IL}			2	-	0.5	-	0.5	V	
				4.5	-	1.35 (Note 1)	-	1.35 (Note 1)	V	
				6	-	1.8	-	1.8	V	
High Level Output Voltage	CMOS Loads V_{OH}	V_{IL} or V_{IH}	$I_O = -20\mu\text{A}$	2	1.9	-	1.9	-	V	
				4.5	4.4 (Note 1)	-	4.4 (Note 1)	-	V	
				6	5.9	-	5.9	-	V	
TTL Loads (Table 1)		V_{IL} or V_{IH}	I_O (mA)	4.5	3.98 (Note 1)	-	3.7 (Note 1)	-	V	
				-4	-	-	-	-	V	
Low Level Output Voltage	CMOS Loads V_{OL}	V_{IL} or V_{IH}	$I_O = 20\mu\text{A}$	2	-	0.1	-	0.1	V	
				4.5	-	0.1 (Note 1)	-	0.1 (Note 1)	V	
				6	-	0.1	-	0.1	V	
TTL Loads (Table 1)		V_{IL} or V_{IH}	I_O (mA)	4.5	0.26 (Note 1)	-	0.4 (Note 1)	-	V	
			-4	-	-	-	-	-	V	
Input Leakage Current	I_{IN}	V_{CC} or GND		6	-	± 0.1 (Note 1)	-	± 1 (Note 1)	μA	
Quiescent Device Current	MSI	I_{CC}	V_{CC} or GND	$I_{OUT} = 0$	6	-	8 (Note 1)	-	160 (Note 1)	μA

NOTE:

1. These limits are tested 100%.

DC Electrical Specifications - CD54HCT Series

PARAMETERS	SYMBOL	TEST CONDITIONS			$T_A = +25^\circ\text{C}$		$T_A = -55^\circ\text{C}$ TO $+125^\circ\text{C}$		UNITS
		V_{IN} (V)		V_{CC} (V)	MIN	MAX	MIN	MAX	
High Level Input Voltage	V_{IH}			4.5	2 (Note 1)	-	2 (Note 1)	-	V
				5.5	2	-	2	-	V
Low Level Input Voltage	V_{IL}			4.5	-	0.8 (Note 1)	-	0.8 (Note 1)	V
				5.5	-	0.8	-	0.8	V

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DC Electrical Specifications - CD54HCT Series (Continued)

PARAMETERS	SYMBOL	TEST CONDITIONS			$T_A = +25^\circ C$		$T_A = -55^\circ C \text{ TO } +125^\circ C$		UNITS
		V_{IN} (V)		V_{CC} (V)	MIN	MAX	MIN	MAX	
High Level Output Voltage CMOS Loads	V_{OH}	V_{IL} or V_{IH}	$I_O = -20\mu A$	4.5	4.4 (Note 1)	-	4.4 (Note 1)	-	V
		V_{IL} or V_{IH}	$I_O = -4mA$	4.5	3.98 (Note 1)	-	3.7 (Note 1)	-	V
Low Level Output Voltage CMOS Loads	V_{OL}	V_{IL} or V_{IH}	$I_O = 20\mu A$	4.5	-	0.1 (Note 1)	-	0.1 (Note 1)	V
		V_{IL} or V_{IH}	$I_O = 4mA$	4.5	-	0.26 (Note 1)	-	0.4 (Note 1)	V
Input Leakage Current	I_{IN}	V_{CC} or GND		6	-	± 0.1 (Note 1)	-	± 1 (Note 1)	μA
Quiescent Device Current MSI	I_{CC}	V_{CC} or GND	$I_{OUT} = 0$	6	-	8 (Note 1)	-	160 (Note 1)	μA
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	ΔI_{CC} (Note 2)	V_{CC} - 2.1		4.5 to 5.5	-	360	-	490	μA

NOTES:

1. These limits are tested 100%.
2. For dual-supply systems theoretical worst case ($V_I = 2.4V$, $V_{CC} = 5.5V$), specification is 1.8mA.

HCT INPUT LOAD TABLE

INPUT	UNIT LOAD (NOTE 1)
All	1

NOTE:

1. Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., $360\mu A$ Max at $+25^\circ C$.

Table 1. TTL Output Load Characteristics - CD54HC/HCT Series

PARAMETERS	SYMBOL	TEMP	TEST CONDITIONS					LIMITS		UNITS	
			HC/HCT			V_{IN}					
			V_{CC}	V_O	I_O	V_{IL} OR V_{IH}	V_{IL} OR V_{IH}	MIN	MAX		
Output High (Source) Current, TTL Load	I_{OH}	$+25^\circ C$	4.5	3.98	-	0, 4.5	0, 4.5	-4 (Note 1)	-	mA	
		$-55^\circ C$	4.5	3.70	-	0, 4.5	0, 4.5	-4 (Note 1)	-	mA	
		$+125^\circ C$	4.5	3.70	-	0, 4.5	0, 4.5	-4 (Note 1)	-	mA	
Output Low (Sink) Current, TTL Load	I_{OL}	$+25^\circ C$	4.5	0.26	-	0, 4.5	0, 4.5	4 (Note 1)	-	mA	
		$-55^\circ C$	4.5	0.40	-	0, 4.5	0, 4.5	4 (Note 1)	-	mA	
		$+125^\circ C$	4.5	0.40	-	0, 4.5	0, 4.5	4 (Note 1)	-	mA	

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Table 1. TTL Output Load Characteristics - CD54HC/HCT Series (Continued)

PARAMETERS	SYMBOL	TEMP	TEST CONDITIONS						LIMITS		UNITS
			HC/HCT			V _{IN}		HC	HCT		
			V _{CC}	V _O	I _O	V _{IL} OR V _{IH}	V _{IL} OR V _{IH}	MIN	MAX		
High Level Output Voltage, TTL Load	V _{OH}	+25°C	4.5	-	-4	1.35, 3.15	0.8, 2.0	3.98 (Note 1)	-	-	V
		-55°C	4.5	-	-4	1.35, 3.15	0.8, 2.0	3.70 (Note 1)	-	-	V
		+125°C	4.5	-	-4	1.35, 3.15	0.8, 2.0	3.70 (Note 1)	-	-	V
Low Level Output Voltage, TTL Load	V _{OL}	+25°C	4.5	-	4	1.35, 3.15	0.8, 2.0	-	0.26 (Note 1)	-	V
		-55°C	4.5	-	4	1.35, 3.15	0.8, 2.0	-	0.40 (Note 1)	-	V
		+125°C	4.5	-	4	1.35, 3.15	0.8, 2.0	-	0.40 (Note 1)	-	V

NOTE:

1. These limits are tested 100%.

Switching Speed

(NOTE 1) PARAMETERS	SYMBOL	TEST CONDITIONS	T _A = +25°C				T _A = -55°C TO +125°C				UNITS
			HC		HCT		HC		HCT		
			V _{CC} (V)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
Propagation Delay Any Input to \bar{Y}	t _{PLH} , t _{PHL}	2	-	150	-	-	-	225	-	-	ns
		4.5	-	30 (Note 2)	-	35 (Note 2)	-	45 (Note 2)	-	53 (Note 2)	ns
		6	-	26	-	-	-	38	-	-	ns
Output Transition Times	t _{TLH} , t _{THL}	2	-	75	-	-	-	110	-	-	ns
		4.5	-	15	-	15	-	22	-	22	ns
		6	-	13	-	-	-	19	-	-	ns
Input Capacitance	C _I	-	-	10	-	10	-	10	-	10	pF

NOTES:

1. Switching Parameter: C_L = 50pF, Input t_R, t_R = 6ns.
2. These limits are tested 100%.

Burn-In Test Circuit Connections Use DC II for F3A Burn-In and AC for Life Test. (Note 1)

	DC BURN-IN I			DC BURN-IN II		
DC	OPEN	GROUND	V _{CC} (6V)	OPEN	GROUND	V _{CC} (6V)
CD54HC/HCT42	1-7, 9-11	8, 12-15	16	1-7, 9-11	8	12-16
AC	OPEN	GROUND	1/2 V _{CC} (3V)	V _{CC} (6V)	OSCILLATOR	
					50kHz	25kHz
CD54HC/HCT42	-	8, 12	1-7, 9-11	16	14, 15	13

NOTE:

1. Each pin except V_{CC} and GND will have a resistor of 2kΩ to 47kΩ.